ROGERS CORPORATION

Data Sheet





Features:

- Lowest electrical loss for reinforced PTFE material
- Low moisture absorption
- Isotropic
- Uniform electrical properties over frequency
- Excellent chemical resistance

Some Typical Applications:

- Commercial Airline Broadband Antennas
- Microstrip and Stripline Circuits
- Millimeter Wave Applications
- Military Radar Systems
- Missile Guidance Systems
- Point to Point Digital Radio Antennas

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PROPERTY	TYPICAL VALUES RT/ 5870		RT/ 5880		DIRECTION	UNITS[3]	CONDITION	TEST METHOD
[1]Dielectric Constant, r Process	2.33 2.33 ± 0.02 spec.		2.20 2.20 ± 0.02 spec.		Z Z	N/A	C24/23/50 C24/23/50	1 MHz IPC-TM-650 2.5.5.3 10 GHz IPC-TM 2.5.5.5
[4]Dielectric Constant, r Design	2.33		2.20		Z	N/A	8 GHz - 40 GHz	Differential Phase Length Method
Dissipation Factor, tan	0.0005 0.0012		0.0004 0.0009		Z Z	N/A	C24/23/50 C24/23/50	1 MHz IPC-TM-650, 2.5.5.3 10 GHz IPC-TM-2.5.5.5
Thermal Coefficient of r	-115		-125		Z	ppm/°C	-50 - 150°C	IPC-TM-650, 2.5.5.5
Volume Resistivity	2 X 10^7		2 X 10^7		Z	Mohm cm	C96/35/90	ASTM D257
Surface Resistivity	2 X 10^7		3 X 10^7		Z	Mohm	C/96/35/90	ASTM D257
Specific Heat	0.96 (0.23)		0.96 (0.23)		N/A	J/g/K (cal/g/C)	N/A	Calculated
Tensile Modulus	Test at 23 °C	Test at 100 °C	Test at 23 °C	Test at 100 °C	N/A	MPa (kpsi)	A	ASTM D638
	1300 (189)	490 (71)	1070 (156)	450 (65)	X			
	1280 (185)	430 (63)	860 (125)	380 (55)	Y			
ultimate stress	50 (7.3)	34 (4.8)	29 (4.2)	20 (2.9)	X			
	42 (6.1)	34 (4.8)	27 (3.9)	18 (2.6)	Y			
ultimate strain	9.8	8.7	6.0	7.2	X	%		
	9.8	8.6	4.9	5.8	Y			
Compressive Modulus	1210 (176)	680 (99)	710 (103)	500 (73)	X	MPa (kpsi)	A	ASTM D695
	1360 (198)	860 (125)	710 (103)	500 (73)	Y			
	803 (120)	520 (76)	940 (136)	670 (97)	Z			
ultimate stress	30 (4.4)	23 (3.4)	27 (3.9)	22 (3.2)	X			
	37 (5.3)	25 (3.7)	29 (5.3)	21 (3.1)	Y			
	54 (7.8)	37 (5.3)	52 (7.5)	43 (6.3)	Z			
ultimate strain	4.0	4.3	8.5	8.4	X	%		
	3.3	3.3	7.7	7.8	Y			
	8.7	8.5	12.5	17.6	Z			
Moisture Absorption	0.02		0.02		N/A	%	.062" (1.6mm) D48/50	ASTM D570
Thermal Conductivity	0.22		0.20		Z	W/m/K	80°C	ASTM C518
Coefficient of Thermal Expansion	22 28 173		31 48 237		X Y Z	ppm/°C	0-100°C	IPC-TM-650, 2.4.41
Td	500		500		N/A	°C TGA	N/A	ASTM D3850
Density	2.2		2.2		N/A	gm/cm^3	N/A	ASTM D792
Copper Peel	27.2 (4.8)		31.2 (5.5)		N/A	pli (N/mm)	1 oz (35mm) EDC foil after solder float	IPC-TM-650 2.4.8
Flammability	V-0		V-0		N/A	N/A	N/A	UL94
Lead-Free Process Compatible	Yes		Yes		N/A	N/A	N/A	N/A

[1] Specification values are measured per IPC-TM-650, method 2.5.5.5 @ ~10GHz, 23°C. Testing based on 1 oz. electrodeposited copper foil. e, values and tolerance reported by IPC-TM-650 method 2.5.5.5 are the basis for quality acceptance, but for some products these values may be incorrect for design purposes, especially microstrip designs. We recommend that prototype boards for new designs be verified for desired electrical performance.
[2] Typical values should not be used for specification limits, except where noted.
[3] SI unit given first with other frequently used units in parentheses.
[4] The design Dk is an average number from several different tested lots of material and on the most common thickness/s. If more detailed information is required, please contact Rogers Corporation. Refer to Rogers' technical paper "Dielectric Properties of High Frequency Materials" available at http://www.rogerscorp.com.

S T	S P S	S C C	N -S C C
0.005" (0.127mm) 0.031" (0.787mm) 0.010" (0.254mm) 0.062" (1.575mm) 0.015" (0.381mm) 0.020" (0.508mm) Non-standard thicknesses are available	18" X 12" (457 X 305mm) 18" X 24" (457 X 610mm) Non-standard sizes may be available up to 18" X 48" (457 X 1219 mm)	½ oz. (18µm) and 1 oz. (35µm) electrodeposited and rolled copper foil	¼ oz. (9 µm) electrodeposited copper foil ½ oz. (18µm), 1 oz. (35µm) and 2 oz. (70µm) reverse treat copper foil 2 oz. (70µm) electrodeposited and rolled copper foil
		Thick metal claddings may be available based on dielectric and plate thickness. Contact customer service for more information on available non-standard and custom thicknesses, claddings and panel sizes	

T R I T R

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